

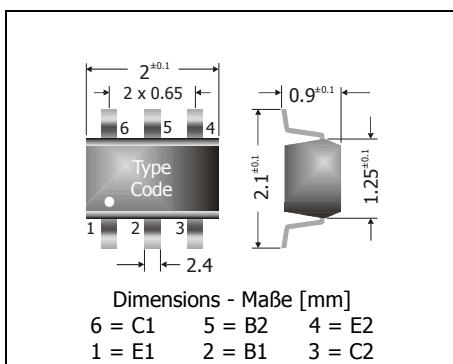
BC846S ... BC849S

NPN

Surface Mount General Purpose Si-Epi-Planar Double-Transistors
Si-Epi-Planar Universal-Doppeltransistoren für die Oberflächenmontage

NPN

Version 2015-02-23

Power dissipation
Verlustleistung

300 mW

Plastic case
Kunststoffgehäuse

SOT-363

Weight approx. – Gewicht ca.

0.01 g

Plastic material has UL classification 94V-0
Gehäusematerial UL94V-0 klassifiziertStandard packaging taped and reeled
Standard Lieferform gegurtet auf Rolle

Maximum ratings ($T_A = 25^\circ\text{C}$)

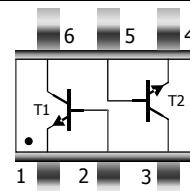
per transistor – pro Transistor		BC846S	BC847S	BC848S BC849S
Collector-Emitter-volt. – Kollektor-Emitter-Spannung B open	V_{CBO}	65 V	45 V	30 V
Collector-Base-voltage – Kollektor-Basis-Spannung E open	V_{CEO}	80 V	50 V	30 V
Emitter-Base-voltage – Emitter-Basis-Spannung C open	V_{EBO}	6 V		5 V
Power dissipation – Verlustleistung	P_{tot}	300 mW ¹⁾		
Collector current – Kollektorstrom (dc)	I_C	100 mA		
Peak Collector current – Kollektor-Spitzenstrom	I_{CM}	200 mA		
Peak Base current – Basis-Spitzenstrom	I_{BM}	200 mA		
Peak Emitter current – Emitter-Spitzenstrom	$-I_{EM}$	200 mA		
Junction temperature – Sperrsichttemperatur	T_j	-55...+150°C		
Storage temperature – Lagerungstemperatur	T_s	-55...+150°C		

Characteristics ($T_j = 25^\circ\text{C}$)

per transistor – pro Transistor		Min.	Typ.	Max.
DC current gain – Kollektor-Basis-Stromverhältnis $V_{CE} = 5 \text{ V}, I_C = 10 \mu\text{A}$ $V_{CE} = 5 \text{ V}, I_C = 2 \text{ mA}$	H_{FE} h_{FE}	– 110	90 ... 270 –	– 800
h-Parameters at/bei $V_{CE} = 5 \text{ V}, I_C = 2 \text{ mA}, f = 1 \text{ kHz}$				
Small signal current gain – Kleinsignal-Stromverstärkung	h_{fe}	–	220 ... 600	–
Input impedance – Eingangs-Impedanz	h_{ie}	1.6 kΩ	–	15 kΩ
Output admittance – Ausgangs-Leitwert	h_{oe}	18 μS	–	110 μS
Reverser voltage transfer ratio – Spannungsrückwirkung	h_{re}	–	1.5 ... 3*10 ⁻⁴	–

¹⁾ Mounted on P.C. board with 3 mm² copper pad at each terminal
 Montage auf Leiterplatte mit 3 mm² Kupferbelag (Lötpad) an jedem Anschluss

Characteristics ($T_j = 25^\circ\text{C}$)Kennwerte ($T_j = 25^\circ\text{C}$)

per transistor – pro Transistor	Min.	Typ.	Max.		
Collector-Emitter saturation voltage – Kollektor-Sättigungsspannung ²⁾ $I_C = 10 \text{ mA}, I_B = 0.5 \text{ mA}$ $I_C = 100 \text{ mA}, I_B = 5 \text{ mA}$	V_{CEsat} –	90 mV 200 mV	250 mV 650 mV		
Base-Emitter saturation voltage – Basis-Sättigungsspannung ²⁾ $I_C = 10 \text{ mA}, I_B = 0.5 \text{ mA}$ $I_C = 100 \text{ mA}, I_B = 5 \text{ mA}$	V_{BEsat} –	700 mV 900 mV	–		
Base-Emitter-voltage – Basis-Emitter-Spannung ²⁾ $V_{CE} = 5 \text{ V}, I_C = 2 \text{ mA}$ $V_{CE} = 5 \text{ V}, I_C = 10 \text{ mA}$	V_{BE} V_{BE} –	580 mV –	660 mV 700 mV 770 mV		
Collector-Base cutoff current – Kollektor-Basis-Reststrom $V_{CB} = 30 \text{ V}, (\text{E open})$ $V_{CE} = 30 \text{ V}, T_j = 125^\circ\text{C}, (\text{E open})$	I_{CBO} I_{CBO} –	– –	15 nA 5 μA		
Emitter-Base cutoff current $V_{EB} = 5 \text{ V}, (\text{C open})$	I_{EBO}	–	– 100 nA		
Gain-Bandwidth Product – Transitfrequenz $V_{CE} = 5 \text{ V}, I_C = 10 \text{ mA}, f = 100 \text{ MHz}$	f_T	100 MHz	– –		
Collector-Base Capacitance – Kollektor-Basis-Kapazität $V_{CB} = 10 \text{ V}, I_E = i_e = 0, f = 1 \text{ MHz}$	C_{CBO}	–	2 pF –		
Emitter-Base Capacitance – Emitter-Basis-Kapazität $V_{EB} = 0.5 \text{ V}, I_C = i_c = 0, f = 1 \text{ MHz}$	C_{EBO}	–	9 pF –		
Thermal resistance junction to ambient air Wärmewiderstand Sperrsicht – umgebende Luft	R_{thA}	< 420 K/W ¹⁾			
Recommended complementary PNP transistors Empfohlene komplementäre PNP-Transistoren	BC856S ... BC859S				
Pinning – Anschlussbelegung T1: E1 = 1, C1 = 6, B1 = 2 T2: E2 = 4, C2 = 3, B2 = 5					

2 Tested with pulses $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$ – Gemessen mit Impulsen $t_p = 300 \mu\text{s}$, Schaltverhältnis $\leq 2\%$ 1 Mounted on P.C. board with 3 mm^2 copper pad at each terminal
Montage auf Leiterplatte mit 3 mm^2 Kupferbelag (Lötpad) an jedem Anschluss